**Product data sheet** 

# 1. General description

Standard reverse recovery power diode in a TO220F package.





### 2. Features and benefits

- · Low forward voltage drop
- Low leakage current
- · High voltage capability
- · High inrush current capability

# 3. Applications

- Oring diode
- Bypass diode
- · Input rectifier for bridge configurations

### 4. Quick reference data

### Table 1. Quick reference data

Symbol	Parameter	Conditions	Notes		Values		Unit		
Absolute	Absolute maximum rating								
$V_{RRM}$	V <sub>RRM</sub> repetitive peak reverse voltage						V		
$I_{F(AV)}$	average forward current	$\delta$ = 0.5 ; square-wave pulse; <u>Fig. 1</u> ; <u>Fig. 2</u>			35		А		
I <sub>FSM</sub>	non-repetitive peak forward current	$t_p$ = 10 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse; Fig. 3		400		А			
		$t_p = 8.3 \text{ ms}; T_{j(init)} = 25 \text{ °C}; \text{ sine-wave pulse}$			435		Α		
Symbol	Parameter	Conditions	Notes	Min	Тур	Max	Unit		
Static ch	Static characteristics								
V <sub>F</sub>	forward voltage	I <sub>F</sub> = 35 A; T <sub>j</sub> = 25 °C; <u>Fig. 5</u>		-	1.18	1.40	V		
I <sub>R</sub>	reverse current	V <sub>R</sub> = 1600 V; T <sub>j</sub> = 25 °C		-	-	50	μΑ		

# 5. Pinning information

**Table 2. Pinning information** 

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	K	cathode		K — A
2	А	anode	000	001aaa020
mb	n.c.	mounting base; isolated		

# 6. Ordering information

### **Table 3. Ordering information**

Type number	Package name	Orderable part number	Packing method	Small packing quantity	. •	Package issue date
WND35P16X	TO220F-2L	WND35P16XQ	Tube	50	TO220Fd-2L	02-Aug-2022

# 7. Marking

### **Table 4. Marking codes**

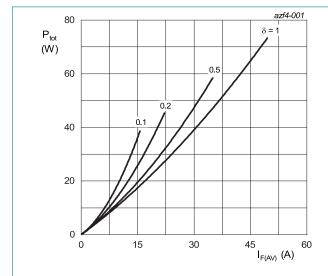
Type number	Marking codes
WND35P16X	WND35P16X

# 8. Limiting values

### **Table 5. Limiting values**

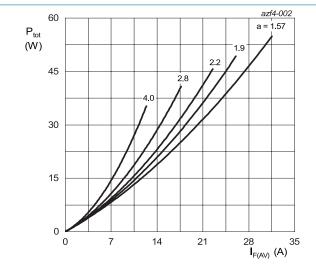
In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Notes	Values	Unit
$V_{RRM}$	repetitive peak reverse voltage			1600	V
$V_{\text{RWM}}$	crest working reverse voltage			1600	V
V <sub>R</sub>	reverse voltage	DC		1600	V
I <sub>F(AV)</sub>	average forward current	$\delta$ = 0.5; square-wave pulse; Fig. 1; Fig. 2		35	Α
I <sub>FSM</sub>	non-repetitive peak forward current	$t_p$ = 10 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse; Fig. 3		400	A
		$t_p$ = 8.3 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse		435	Α
l <sup>2</sup> t	I <sup>2</sup> t for fusing	$t_p$ = 10 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse		800	A <sup>2</sup> s
T <sub>stg</sub>	storage temperature			-40 to 150	°C
T <sub>j</sub>	junction temperature			-40 to 150	°C



 $I_{F(AV)} = I_{F(RMS)} \times \sqrt{\delta}$  $V_o = 1.025 \text{ V}; R_s = 0.0092 \Omega$ 

Fig. 1. Forward power dissipation as a function of average forward current; square waveform; maximum values



a = form factor =  $I_{F(RMS)}$  /  $I_{F(AV)}$ V<sub>o</sub> = 1.025 V; R<sub>s</sub> = 0.0092  $\Omega$ 

Fig. 2. Forward power dissipation as a function of average forward current; sinusoidal waveform; maximum values

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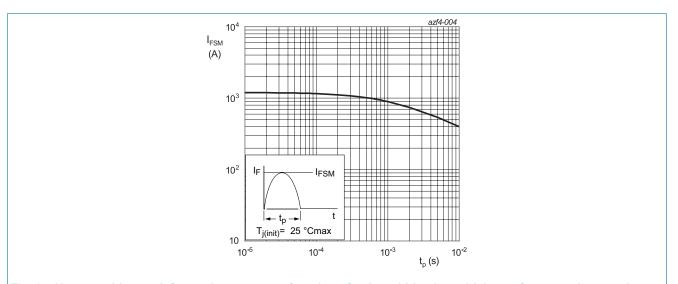


Fig. 3. Non-repetitive peak forward current as a function of pulse width; sinusoidal waveform; maximum values

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## 9. Thermal characteristics

**Table 6. Thermal characteristics** 

Symbol	Parameter	Conditions	Notes	Min	Тур	Max	Unit
$R_{th(j-h)}$	thermal resistance from junction to heatsink	Fig. 4		-	-	3.2	K/W
R <sub>th(j-a)</sub>	thermal resistance from junction to ambient free air	in free air		-	60	-	K/W

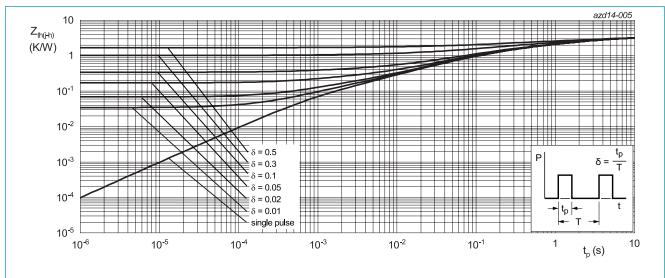


Fig. 4. Transient thermal impedance from junction to heatsink as a function of pulse duration

### 10. Isolation characteristics

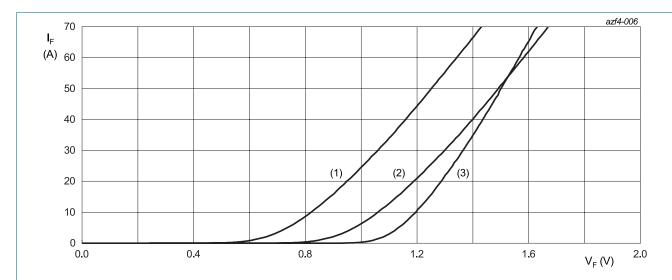
**Table 7. Isolation characteristics** 

Symbol	Parameter	Conditions	Notes	Min	Тур	Max	Unit
V <sub>isol(RMS)</sub>	RMS isolation voltage	50 Hz ≤ f ≤ 60 Hz; RH ≤ 65 %; from all pins to external heatsink; sinusoidal waveform; clean and dust free		-	-	2500	V
C <sub>isol</sub>	isolation capacitance	from cathode to external heatsink		-	10	-	PF

# 11. Characteristics

### **Table 8. Characteristics**

Symbol	Parameter	Conditions	Notes	Min	Тур	Max	Unit
Static cha	racteristics						
$V_{F}$	forward current	I <sub>F</sub> = 35 A; T <sub>j</sub> = 25 °C; <u>Fig. 5</u>		-	1.18	1.40	V
		I <sub>F</sub> = 35 A; T <sub>j</sub> = 150 °C; <u>Fig. 5</u>		-	1.15	1.35	V
I <sub>R</sub>	reverse current	V <sub>R</sub> = 1600 V; T <sub>j</sub> = 25 °C		-	-	50	μA
		V <sub>R</sub> = 1600 V; T <sub>j</sub> = 150 °C		-	-	1	mA

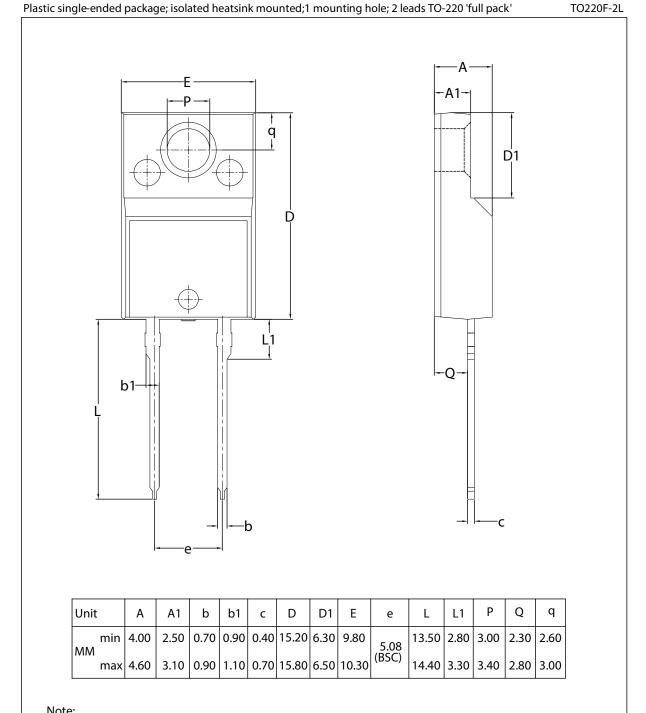


 $V_o = 1.025 \text{ V}; R_s = 0.0092 \Omega$ 

(1)  $T_j = 150 \,^{\circ}\text{C}$ ; typical values (2)  $T_j = 150 \,^{\circ}\text{C}$ ; maximum values (3)  $T_j = 25 \,^{\circ}\text{C}$ ; maximum values

Fig. 5. Forward current as a function of forward voltage

# 12. Package outline



#### Note:

All dimensions don't include mold flash and metal protrusion.

## 13. Legal information

#### Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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